

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

N-Channel enhancement mode power MOSFET

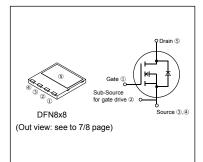
Features

Pb-free lead terminal **RoHS** compliant Halogen-free molding compound MSL:1, Reflow available

Applications

For switching





Package and Internal circuit chart

Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Duain Course Valtere	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current	,	37.1	А	Tc=25°C Note*1,2
Continuous Drain Current	/D	23.5	А	Tc=100°C Note*1,2
Pulsed Drain Current	I _{DP}	108.0	А	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	las	4.4	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	708.1	mJ	Note *4
Maximum MOSFET dv/dt	dv _{DS} /dt	50	V/ns	V _{DS} ≤ 600V
Continuous	,	37.1	А	Tc=25°C Note*1,2
Diode Forward Current	<i>I</i> _{DR}	23.5	А	Tc=100°C Note*1,2
Pulsed Diode Forward Current	IDRP	108.0	А	Note *2
Peak Diode Recovery dv/dt	dv/dt	30	V/ns	Note *5
Peak Diode Recovery -d <i>i</i> _{DR} /d <i>t</i>	-d <i>i</i> _{DR} /d <i>t</i>	100	A/µs	Note *6
Maximum Bower Discinction	P _{tot}	208	W	<i>T</i> c=25°C
Maximum Power Dissipation	r tot	2.78	W	<i>T</i> ₂=25°C
Operating Channel Temperature	Tch	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.55

Note *1 : Maximum duty cycle D=0.53 Note *2 : Limited by maximum channel temperature. Note *3 : Trate 150 °C, See Figure 1 and 2. Note *4 : Starting Trate 25 °C, IAS = 2.7 A, L = 178 mH, Vop = 60 V, Rs = 50 Ω , See Figure 1 and 2. EAS limited by maximum channel temperature and avalanche current.

EAS limited by intermining transfer on period and statistical terms of the second state of the second sta

Electrical Characteristics at Tc=25°C (unless otherwise specified) Static characteristics

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V I _D = 250 μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{\text{DS}} = V_{\text{GS}}$ $I_{\text{D}} = 4.4 \text{ mA}$		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	loss	V _{DS} = 600 V V _{GS} = 0 V	<i>T</i> _{ch} = 25 °C	-	-	25	μA
		V _{DS} = 480 V V _{GS} = 0 V	<i>T</i> _{ch} = 125 °C	-	-	-	
Gate-Source Leakage Current	Igss	$V_{DS} = 0 V$ $V_{GS} = \pm 30 V$		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 7.3 A		-	0.105	0.118	Ω
Gate resistance	r _g	f = 1 MHz, open drain		-	7.8	-	Ω

Dynamic characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g _{fs}	V _{DS} = 25 V I _D = 14.6 A	5.2	21	-	S
Input Capacitance	Ciss	V _{DS} = 400 V	-	1540	-	
Output Capacitance	Coss	$V_{\rm GS} = 0$ V	-	55	-	
Reverse Transfer Capacitance	Crss	<i>f</i> = 250 kHz	-	7.4	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} = 0400 V V _{GS} = 0 V	-	126	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	$V_{DS} = 0400 V$ $V_{GS} = 0 V$ $I_D = constant$	-	511	-	
Turn-On Time	t _{d(on)}	$-V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}$ $I_D = 14.6 \text{ A},$	-	31	-	- ns
	tr		-	22	-	
Turn-Off Time	t _{d(off)}	$R_{\rm G}$ = 24 Ω See Figure 3 and 4	-	232	-	
	<i>t</i> r		-	22	-	
Total Gate Charge	QG	$V_{\rm DD}$ = 400 V, $V_{\rm GS}$ = 10 V	-	75	-	nC
Gate-Source Charge	Q _{GS}	I _D = 29.2 A	-	31	-	
Gate-Drain Charge	QGD	See Figure 5	-	35	-	

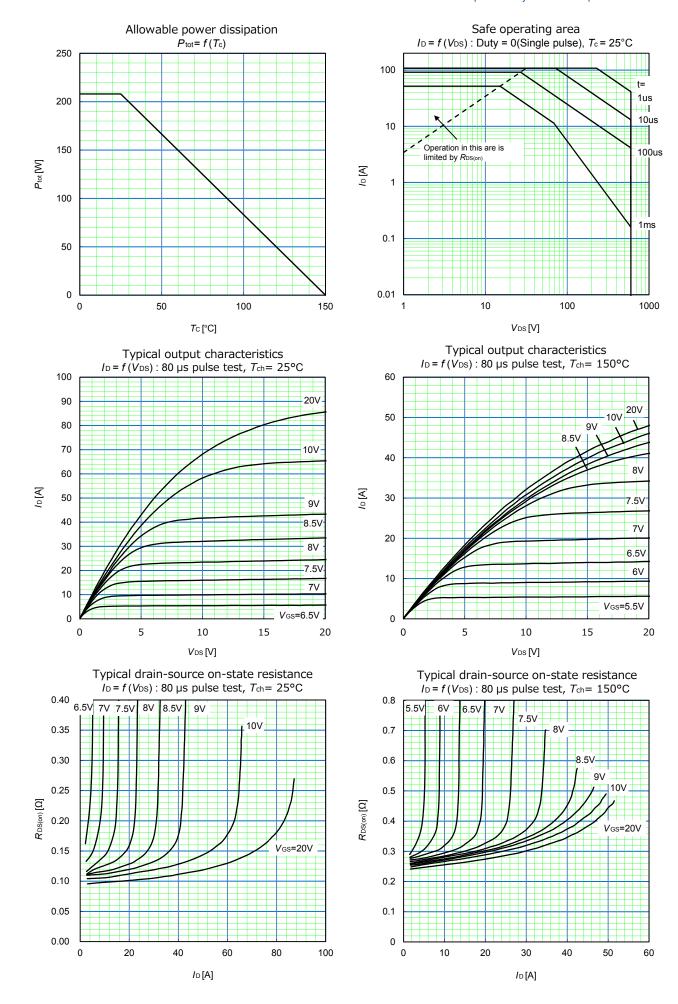
Note *6 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Os} is rising from 0 to 400V. Note *7 : $C_{o(r)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Os} is rising from 0 to 400V.

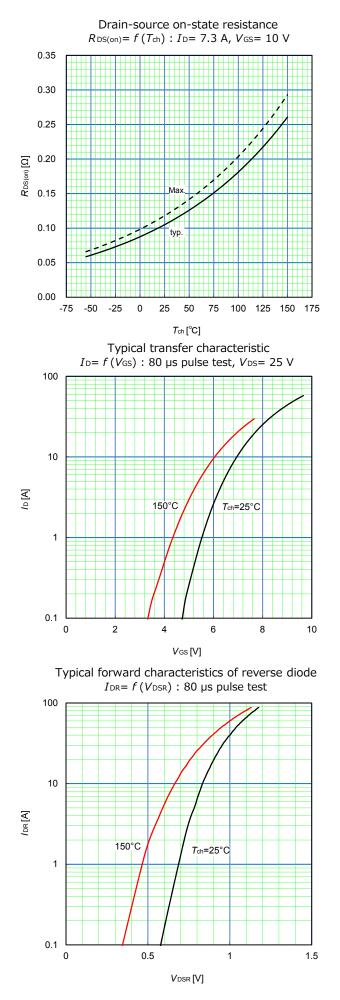
Reverse diode characteristics

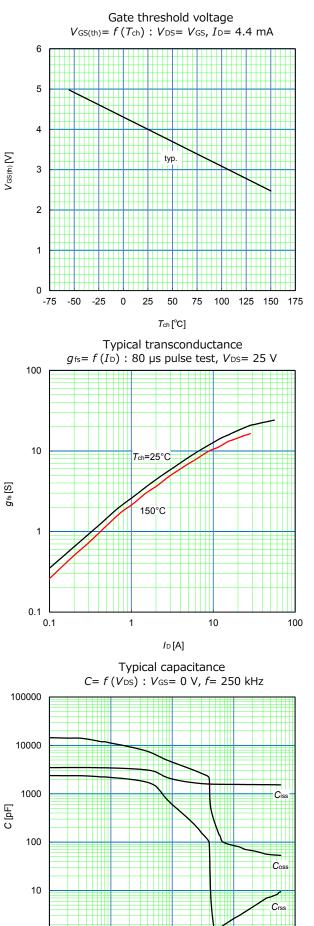
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{dsr}	$I_{DR} = 29.2 \text{ A}, V_{GS} = 0 \text{ V}$ $T_{ch} = 25 \text{ °C}$	-	1.00	1.35	V
Reverse Recovery Time	trr	$V_{DD} = 400 V$ $I_{DR} = 29.2 A$ $V_{GS} = 0 V$ $-d_{DR}/dt = 100 A/\mu s$ $T_{ch} = 25 °C$ See Figure 6 and 7	-	174	-	ns
Reverse Recovery Charge	Qrr		-	1.4	-	μC
Peak Reverse Recovery Current	Irrm		-	14.9	-	A

Thermal Resistance

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Channel – Ambient	$R_{ m th(ch-a)}$	Device mounted on PCB (FR4) Size: 40mm*40mm*1.5mm with 6cm ² copper area (one layer, 70µm thickness) for drain connection and cooling.	-	-	45	°C/W
Thermal Resistance, Channel – Case	$R_{\rm th(ch-c)}$		-	-	0.601	°C/W







1

0.1

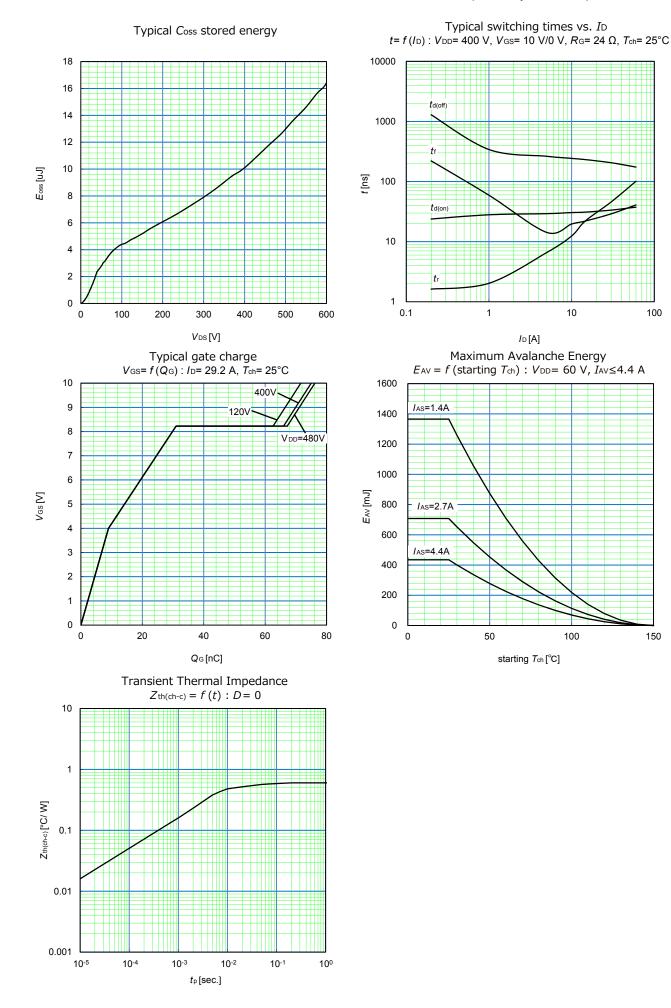
1

10

VDS[V]

100

1000



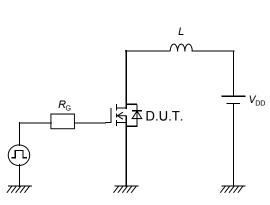


Figure 1. Unclamped inductive load test circuit

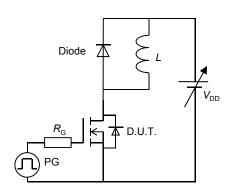


Figure 3. Switching test circuit

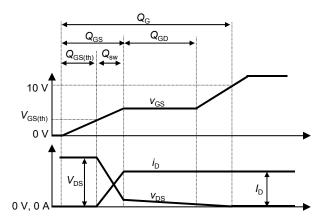


Figure 5. Gate charge waveform

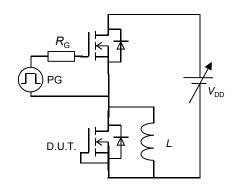
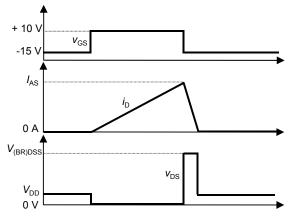
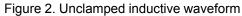


Figure 6. Diode reverse recovery test circuit





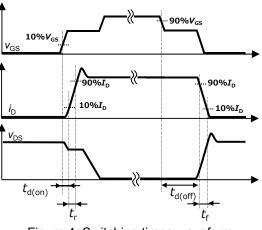
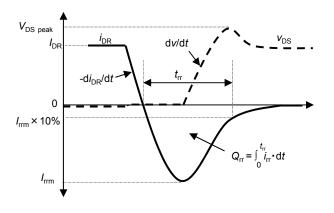
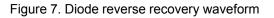


Figure 4. Switching times waveform





0.85±0.1

0.2±0.1

4

2.75±0.1

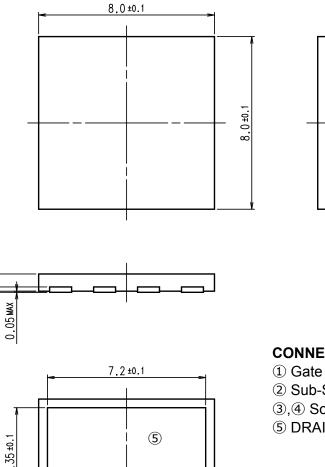
4

1.0±0.1

3

http://www.fujielectric.com/products/semiconductor/

Package Dimensions : DFN8x8 Package



CONNECTION

- ② Sub-Source for Gate Drive
- 3,4 Source
- **⑤ DRAIN**

DIMENSIONS ARE IN MILLIMETERS

Notes

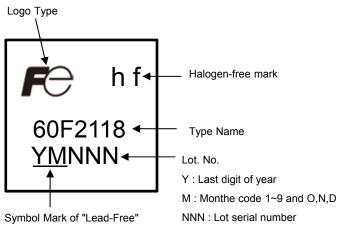
0.5±0.1

1

2.0

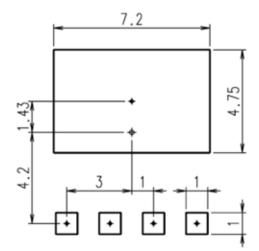
- 1.(): Reference dimensions.
- 2. The metal part is covered with the solder plating, part of cutting is without the solder plating.





* The font (font type,size) and the trademark-size might be actually different.

Recommended footprint



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